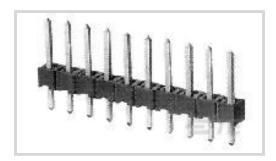
826629-1 ~ ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 826629-1 PCB Mount Header, Vertical, Board-to-Board, 1 Position, 2.54 mm [. 1 in] Centerline, Breakaway, AMPMODU Headers View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 1

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Breakaway
Sealable	No

Connector & Contact Terminates To	Printed Circuit Board					
Configuration Features						
Connector Contact Load Condition	Fully Loaded					
PCB Mount Orientation	Vertical					
Number of Positions	1					
Number of Rows	1					
Board-to-Board Configuration	Parallel					
Electrical Characteristics						
Insulation Resistance	5000 MΩ					
Dielectric Withstanding Voltage (Max)	750 Vrms					
Body Features						
Primary Product Color	Green					
Contact Features						
Mating Square Post Dimension	.63 mm[.025 in]					

PCB Mount Header, Vertical, Board-to-Board, 1 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers



Contact Shape & Form	Square				
Contact Underplating Material	Nickel				
PCB Contact Termination Area Plating Material	Tin				
Contact Base Material	Brass				
Contact Mating Area Plating Material	Gold or Gold Flash over Palladium Nickel				
Contact Mating Area Plating Material Thickness	.8 μm[31.5 μin]				
Contact Type	Pin				
Contact Current Rating (Max)	5 A				
Termination Features					
Square Termination Post & Tail Dimension	.63 mm[.025 in]				
Termination Post & Tail Length	3.2 mm[.126 in]				
Termination Method to Printed Circuit Board	Through Hole - Solder				
Mechanical Attachment					
Mating Alignment	Without				
PCB Mount Retention	Without				
PCB Mount Alignment	Without				
Connector Mounting Type	Board Mount				

Housing Features

Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	PBT
Dimensions	
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	3000

PCB Mount Header, Vertical, Board-to-Board, 1 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers



Packaging Type	Box
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

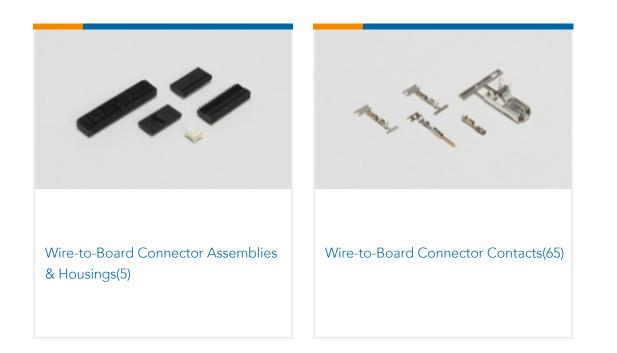
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Also in the Series AMPMODU Headers



PCB Mount Header, Vertical, Board-to-Board, 1 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers





Customers Also Bought



CPF 0603 1K6 0.1% 25PPM 1K RL	HDR, 64P, BLK, RA, AU/NI/CU, AA	HDR, 24P, BLK, RA EEC, AU/NI/CU, AB	V23105A5401A201



Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_826629-1_R.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_826629-1_R.3d_igs.zip

PCB Mount Header, Vertical, Board-to-Board, 1 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers



English

Customer View Model ENG_CVM_CVM_826629-1_R.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance

TE Material Declaration

English

Agency Approvals UL Report English